Onsemi

IGBT - Power, Co-PAK N-Channel, Field Stop IV, MQ (Medium Speed), TO247-4L 650 V, 1.45 V, 75 A FGH4L75T65MQDC50

Using the novel field stop 4th generation IGBT technology and generation 1.5 SiC Schottky Diode technology in TO-247 4-lead package, FGH4L75T65MQDC50 offers the optimum performance with both low conduction and switching losses for high-efficiency operations in various applications, especially totem pole bridgeless PFC and Inverter.

Features

- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- 100% of the Parts are Tested for ILM (Note 2)
- Smooth and Optimized Switching
- Low Saturation Voltage: V_{CE(Sat)} = 1.45 V (Typ.) @ I_C = 75 A
- No Reverse Recovery / No Forward Recovery
- Tight Parameter Distribution
- RoHS Compliant

Applications

- Charging Station (EVSE)
- UPS, ESS
- Solar Inverter
- PFC, Converters

MAXIMUM RATINGS (T_J = $25^{\circ}C$ unless otherwise noted)

| Parame | Symbol | Value | Unit | | | |
|--|----------------------------------|--------------------------------------|----------------|----|--|--|
| Collector-to-Emitter Voltage | | V _{CES} | 650 | V | | |
| Gate-to-Emitter Voltage | | V_{GES} | ±20 | | | |
| Transient Gate-to-Emitter $(t_p < 0.5 \ \mu s, D < 0.001)$ | Voltage | | ±30 | | | |
| Collector Current | T _C = 25°C (Note 1) | Ι _C | 110 | А | | |
| | $T_C = 100^{\circ}C$ | | 75 | | | |
| Power Dissipation | T _C = 25°C | PD | 385 | W | | |
| | $T_{\rm C} = 100^{\circ}{\rm C}$ |] | 192 | | | |
| Pulsed Collector Current | T _C = 25°C (Note 2) | I _{LM} | 300 | А | | |
| | T _C = 25°C (Note 3) | I _{CM} | 300 | | | |
| Diode Forward Current | $T_{C} = 25^{\circ}C$ (Note 1) | ١ _F | 60 | А | | |
| | $T_{C} = 100^{\circ}C$ | | 50 | | | |
| Pulsed Diode Maximum Forward Current | $T_{C} = 25^{\circ}C$ | I _{FM} | 200 | A | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{STG} | –55 to +175 | °C | | |
| Maximum Lead Temperature for Soldering Purposes | | ΤL | 260 | °C | | |
| Stragge eveneding these lis | · · · · · · · | | | | | |

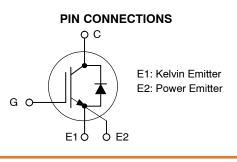
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limit by bond wire

2. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A, Inductive Load, 100% tested

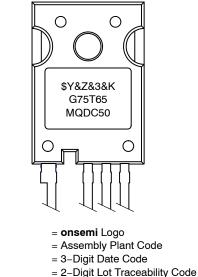
3. Repetitive rating: pulse width limited by max. junction temperature

| BV _{CES} | V _{CE(sat)} | Ι _C |
|-------------------|----------------------|----------------|
| 650 V | 1.45 V | 75 A |





MARKING DIAGRAM



&K G75T65MQDC50 = Specific Device Code

\$Y

&Z

&З

ORDERING INFORMATION

| Device | Package | Shipping |
|------------------|---------|-----------------|
| FGH4L75T65MQDC50 | TO-247 | 30 Units / Tube |
| | –4LD | |

THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|--|------------------------|-------|------|
| Thermal Resistance Junction-to-Case, for IGBT | $R_{\theta JC}$ | 0.39 | °C/W |
| Thermal Resistance Junction-to-Case, for Diode | $R_{	extsf{	heta}JCD}$ | 0.74 | |
| Thermal Resistance Junction-to-Ambient | R_{\thetaJA} | 40 | |

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

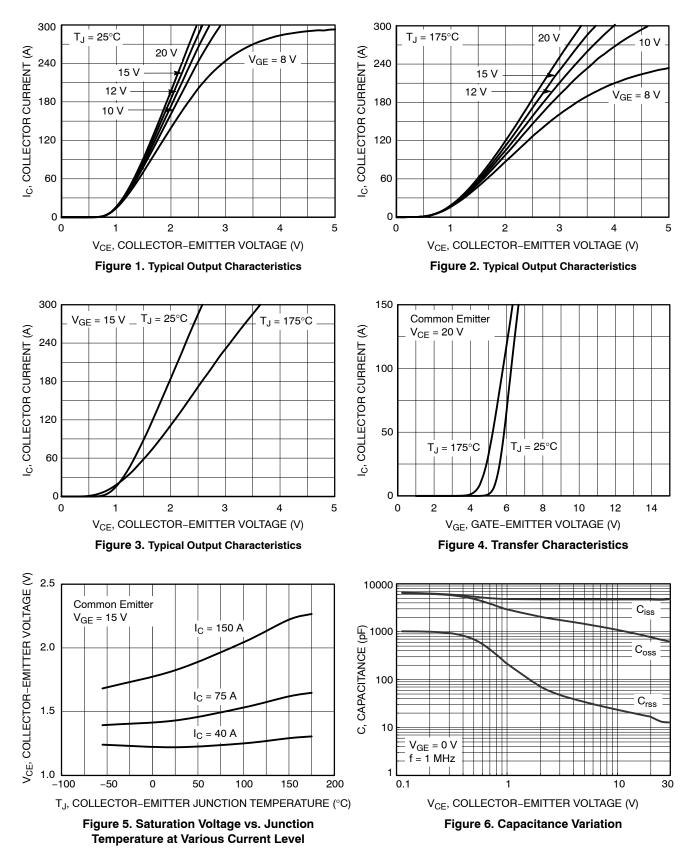
| Parameter | Test Conditions | Symbol | Min | Тур | Мах | Unit |
|--|---|--|-----|------|------|------|
| OFF CHARACTERISTICS | | | | | | |
| Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited | V_{GE} = 0 V, I _C = 1 mA | BV _{CES} | 650 | - | - | V |
| Temperature Coefficient of Breakdown Voltage | V_{GE} = 0 V, I _C = 1 mA | $\frac{\Delta BV_{CES}}{\Delta T_{J}}$ | _ | 0.5 | - | V/°C |
| Collector-emitter Cut-off Current, Gate-emitter Short-circuited | V_{GE} = 0 V, V_{CE} = 650 V | I _{CES} | - | - | 250 | μΑ |
| Gate Leakage Current, Collector-emitter Short-circuited | V_{GE} = 20 V, V_{CE} = 0 V | I _{GES} | - | - | ±400 | nA |
| ON CHARACTERISTICS | | | | | | |
| Gate-emitter Threshold Voltage | $V_{GE} = V_{CE}$, $I_C = 75 \text{ mA}$ | V _{GE(th)} | 3.0 | 4.5 | 6.0 | V |
| Collector-emitter Saturation Voltage | V_{GE} = 15 V, I _C = 75 A, T _J = 25°C | V _{CE(sat)} | - | 1.45 | 1.8 | V |
| | V_{GE} = 15 V, I _C = 75 A, T _J = 175°C | | _ | 1.65 | - | |
| DYNAMIC CHARACTERISTICS | | • | | | | |
| Input Capacitance | V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz | Cies | - | 4770 | - | pF |
| Output Capacitance | | C _{oes} | - | 619 | - | - |
| Reverse Transfer Capacitance | | C _{res} | - | 13 | - | |
| Gate Charge Total | V_{CC} = 400 V, I_{C} = 75 A, V_{GE} = 15 V | Qg | - | 146 | - | nC |
| Gate-to-emitter Charge | | Q _{ge} | - | 26 | - | |
| Gate-to-collector Charge | | Q _{gc} | - | 34 | - | |
| SWITCHING CHARACTERISTICS, INDUC | TIVE LOAD | | | | | |
| Turn-on Delay Time | $T_{J} = 25^{\circ}C, V_{CC} = 400 V,$ | t _{d(on)} | - | 24 | - | ns |
| Rise Time | I_{C} = 37.5 A, R_{G} = 10 Ω , V _{GE} = 15 V, Inductive Load | t _r | - | 16 | - | |
| Turn-off Delay Time | | t _{d(off)} | - | 192 | - | |
| Fall Time | | t _f | - | 16 | - | |
| Turn-on Switching Loss | | Eon | - | 0.31 | - | mJ |
| Turn-off Switching Loss | | E _{off} | - | 0.49 | - | |
| Total Switching Loss | | E _{ts} | - | 0.81 | - | |
| Turn-on Delay Time | $T_{J} = 25^{\circ}C, V_{CC} = 400 V,$ | t _{d(on)} | - | 29 | - | ns |
| Rise Time | I_{C} = 75 A, R_{G} = 10 Ω , V _{GE} = 15 V, Inductive Load | t _r | - | 27 | - | |
| Turn-off Delay Time | | t _{d(off)} | - | 187 | - | |
| Fall Time | | t _f | - | 18 | - | |
| Turn-on Switching Loss | | E _{on} | - | 0.72 | - | mJ |
| Turn-off Switching Loss | | E _{off} | _ | 0.96 | - | |
| Total Switching Loss | | E _{ts} | _ | 1.68 | - | |

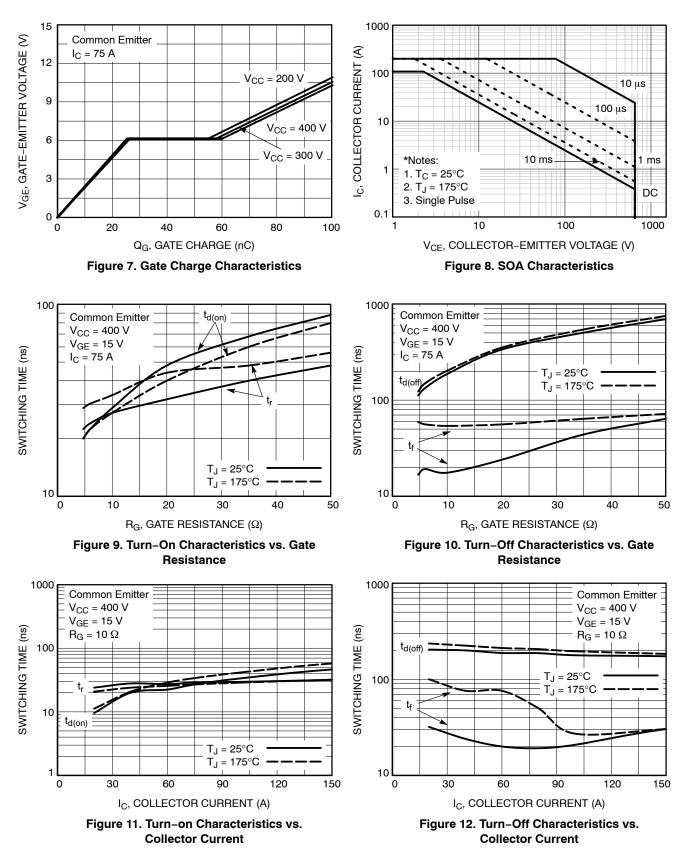
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (continued)

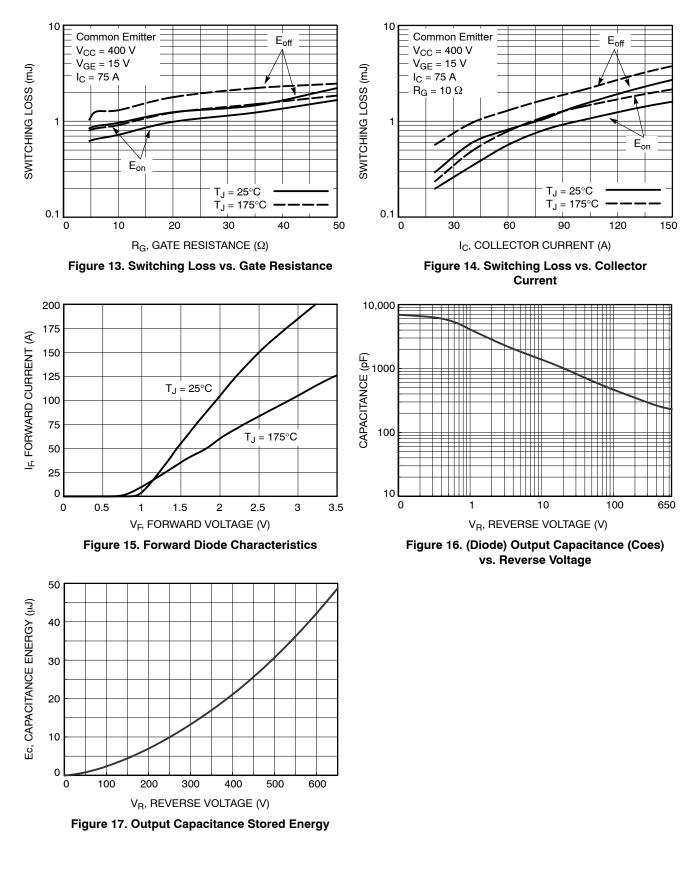
| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|-------------------------------|---|---------------------|-----|------|-----|------|
| SWITCHING CHARACTERISTICS, IN | IDUCTIVE LOAD | • | | | | |
| Turn-on Delay Time | $T_{J} = 175^{\circ}C, V_{CC} = 400 V,$ | t _{d(on)} | - | 24 | - | ns |
| Rise Time | I _C = 37.5 A, R _G = 15 Ω, V _{GE} = 10 V, Inductive Load | tr | - | 20 | - | 1 |
| Turn-off Delay Time | | t _{d(off)} | - | 220 | - | 1 |
| Fall Time | | t _f | - | 72 | - | 1 |
| Turn-on Switching Loss | | Eon | - | 0.41 | - | mJ |
| Turn-off Switching Loss | | E _{off} | - | 0.82 | - | 1 |
| Total Switching Loss | | E _{ts} | - | 1.23 | - | 1 |
| Turn-on Delay Time | $T_{J} = 175^{\circ}C, V_{CC} = 400 V,$ | t _{d(on)} | - | 27 | - | ns |
| Rise Time | I_{C} = 75 A, R_{G} = 15 Ω , V _{GE} = 10 V, Inductive Load | tr | - | 34 | - | 1 |
| Turn-off Delay Time | | t _{d(off)} | - | 202 | - | 1 |
| Fall Time | | t _f | - | 54 | - | 1 |
| Turn-on Switching Loss | | Eon | - | 0.91 | - | mJ |
| Turn-off Switching Loss | | E _{off} | - | 1.30 | - | 1 |
| Total Switching Loss | | E _{ts} | - | 2.20 | - | 1 |

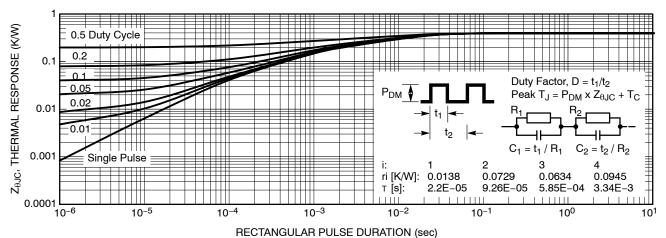
| Diode Forward Voltage | I _F = 50 A, T _J = 25°C | V _F | - | 1.46 | 1.7 | V |
|-----------------------|---|----------------|---|------|-----|----|
| | I _F = 50 A, T _J = 175°C | | - | 1.83 | - | |
| Total Capacitance | V_R = 400 V, f = 1 MHz, T _J = 25°C | С | - | 210 | - | pF |
| | V_R = 600 V, f = 1 MHz, T _J = 25°C | | - | 202 | - | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.











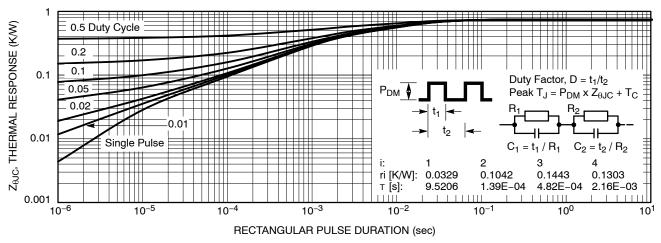
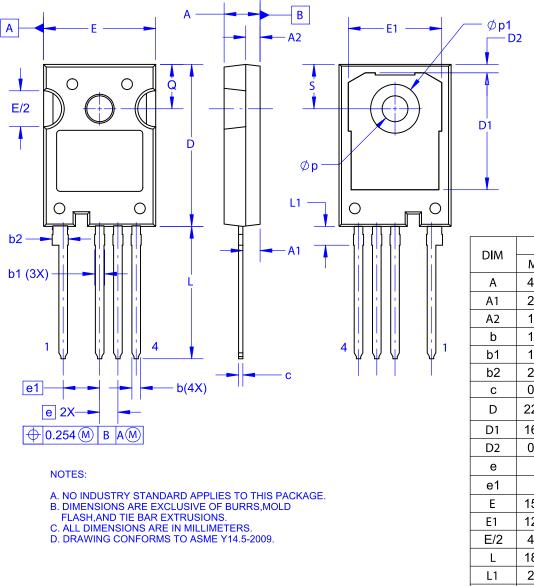


Figure 19. Transient Thermal Impedance of Diode



TO-247-4LD CASE 340CJ ISSUE A

DATE 16 SEP 2019



| | MILLIMETERS | | | | | |
|-----|-------------|------------|-------|--|--|--|
| DIM | MIN | MIN NOM MA | | | | |
| А | 4.80 | 5.00 | 5.20 | | | |
| A1 | 2.10 | 2.40 | 2.70 | | | |
| A2 | 1.80 | 2.00 | 2.20 | | | |
| b | 1.07 | 1.20 | 1.33 | | | |
| b1 | 1.20 | 1.40 | 1.60 | | | |
| b2 | 2.02 | 2.22 | 2.42 | | | |
| С | 0.50 | 0.60 | 0.70 | | | |
| D | 22.34 | 22.54 | 22.74 | | | |
| D1 | 16.00 | 16.25 | 16.50 | | | |
| D2 | 0.97 | 1.17 | 1.37 | | | |
| е | 2 | 2.54 BSC | | | | |
| e1 | Ę | 5.08 BSC | 2 | | | |
| Е | 15.40 | 15.60 | 15.80 | | | |
| E1 | 12.80 | 13.00 | 13.20 | | | |
| E/2 | 4.80 | 5.00 | 5.20 | | | |
| L | 18.22 | 18.42 | 18.62 | | | |
| L1 | 2.42 | 2.62 | 2.82 | | | |
| р | 3.40 | 3.60 | 3.80 | | | |
| p1 | 6.60 | 6.80 | 7.00 | | | |
| Q | 5.97 | 6.17 | 6.37 | | | |
| S | 5.97 | 6.17 | 6.37 | | | |

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